

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# **SURFBOARDS®**

THE BREADBOARDING MEDIUM FOR SURFACE MOUNT THE

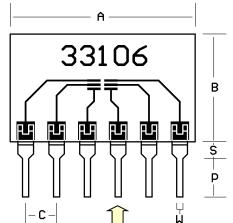


#### 33000 SERIES APPLICATION SPECIFIC ADAPTERS

IDS33106

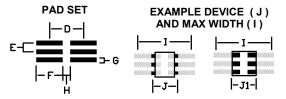
MODEL **33106** 

6 LEAD .35 mm PITCH DEVICES DEVICE LEAD WIDTH .9, 1.0, To Max 2.2 MM



SINGLE-IN-LINE (SIP) PINS ON .100 in. CENTERS

**DRAWINGS** SCALE



MOUNTING PADS ARE OVERSIZED IN LENGTH TO ACCEPT A WIDER RANGE OF DEVICE WIDTHS AND TOLERANCES AND TO PERMIT HAND SOLDERING. **SEE WEBSITE FOR SOLDERING SUGGESTIONS** 

#### **BOARD SPECIFICATIONS**

BOARD MATERIAL: .8mm. +-.13mm .031in+-..005 in. Thick G-10 FR-4 Glass Epoxy or equivalent. CIRCUITS: 1 oz. Copper with RoHS compliant Lead Free solder coating. Patten Position on board +- .5mm .020in.



ACCEPTS SOT-963

#### PARTIAL LISTING

ON SEMI ULLGA6 1.0x1.0,0.35P

**PANASONIC** SSSMini6-F1

TEXAS NST. DSF (S-PDSO-N6)

DSF (S-PX2SON-N6)

**TOSHIBA** CST6, FS6

#### ALWAYS CONSULT DEVICE DATA SHEET TO INSURE PROPER FIT

Feature Pins on .1 in. Centers designed for use with Solderless breadboards, Conventional Breadboards, and Sockets with standard .1 in. centers. Use For Prototyping, Device Test or Evaluation and SMD to Through Hole Conversion.

FIG.	ММ	IN.	NOTE:
Α	15.24	.600	BOARD WIDTH +5mm .020in.
В	8.89	.350	BOARD HEIGHT +5mm .020in.
С	2.54	.100	SIP PIN SPACE +20mm .008in.
D	1.4	.055	PAD CENTERLINE
E	.35	.014	DEVICE LEAD PITCH
F	1.1	.043	PAD LENGTH
G	.2	.008	PAD WIDTH
Н	.3	.012	GAP
- 1	2.2	.087	MAX LEAD WIDTH
J	1.0	.039	TYPICAL LEAD WIDTH
J1	.9	.035	VARIATION LEAD WIDTH
Р	3.3	.130	LENGTH FROM SHOULDER +5mm .020in.
S	1.57	.062	PIN SHOULDER HEGHT
W	.5	.020	PIN WIDTH

TOLERANCES: If not noted are +- 20%. Nominal values are given. Controlling unit is Millimeters Values rounded to nearest decimal. Slight Variations due to manufacturing process can occur.

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